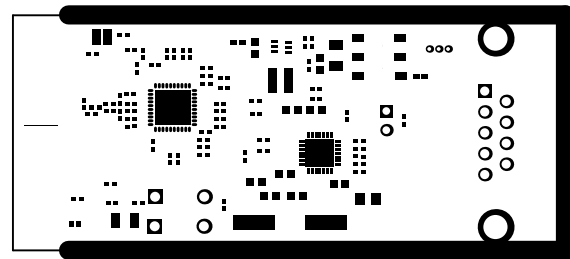
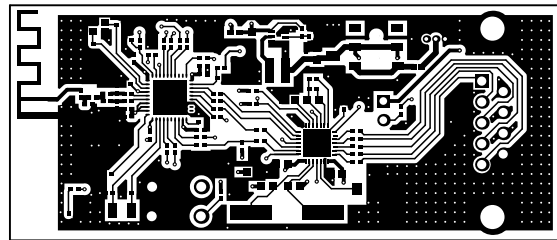


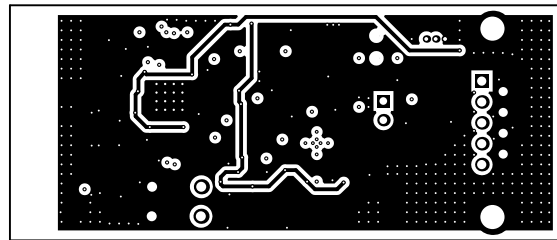
|                                     |                                  |                   |                                |
|-------------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE    | BOARD #: SAT0015                 | REV: E2           | SUN REV: Not In VersionControl |
| LAYER NAME = Mtp OverlayInformation |                                  |                   |                                |
| PLOT NAME = Top Overlay             | GENERATED : 1/22/2014 4:04:25 PM | TEXAS INSTRUMENTS |                                |



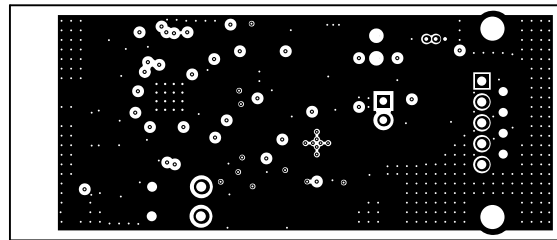
|                                     |                                  |                   |                                |
|-------------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE    | BOARD #: SAT0015                 | REV: E2           | SUN REV: Not In VersionControl |
| LAYER NAME = Top Solder Information |                                  |                   |                                |
| PLOT NAME = Top Solder Mask         | GENERATED : 1/22/2014 4:04:26 PM | TEXAS INSTRUMENTS |                                |



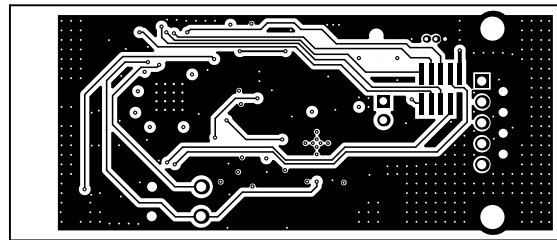
|   |                                  |                   |                                |
|---|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE            | BOARD #: SAT0015                 | REV: E2           | SVN REV: Not In VersionControl |
| LAYER NAME = Mbp <del>Gen</del> Information |                                  |                   |                                |
| PLOT NAME = Top Layer                       | GENERATED : 1/22/2014 4:04:26 PM | TEXAS INSTRUMENTS |                                |



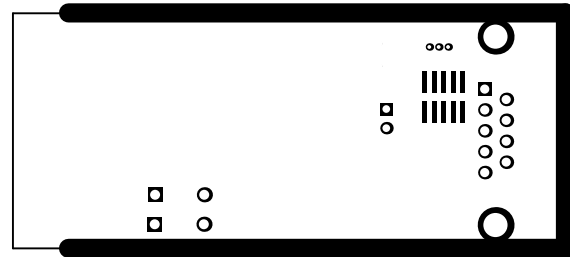
|                                     |                                  |                   |                                |
|-------------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE    | BOARD #: SAT0015                 | REV: E2           | SUN REV: Not In VersionControl |
| LAYER NAME = PblwGerber Information |                                  |                   |                                |
| PLOT NAME = Inner Layer 1           | GENERATED : 1/22/2014 4:04:27 PM | TEXAS INSTRUMENTS |                                |



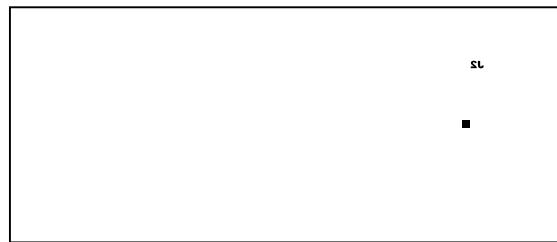
|                                     |                                  |                   |                                |
|-------------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE    | BOARD #: SAT0015                 | REV: E2           | SVN REV: Not In VersionControl |
| LAYER NAME = GND Gerber Information |                                  |                   |                                |
| PLOT NAME = Inner Layer 2           | GENERATED : 1/22/2014 4:04:27 PM | TEXAS INSTRUMENTS |                                |



|  |                                  |                   |                                |
|--|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE               | BOARD #: SAT0015                 | REV: E2           | SUN REV: Not In VersionControl |
| LAYER NAME = <del>Bottom</del> begeinformation |                                  |                   |                                |
| PLOT NAME = Bottom Layer                       | GENERATED : 1/22/2014 4:04:28 PM | TEXAS INSTRUMENTS |                                |

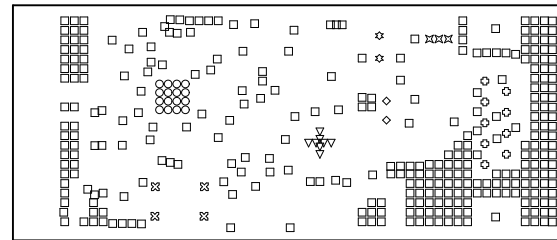


|  |                                  |                   |                                |
|--|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE                       | BOARD #: SAT0015                 | REV: E2           | SUN REV: Not In VersionControl |
| LAYER NAME = <del>Bottom Solder Mask</del> Information |                                  |                   |                                |
| PLOT NAME = Bottom Solder Mask                         | GENERATED : 1/22/2014 4:04:28 PM | TEXAS INSTRUMENTS |                                |



|  |                                  |                   |                                |
|--|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE                   | BOARD #: SAT0015                 | REV: E2           | SUN REV: Not In VersionControl |
| LAYER NAME = <del>Bottom Overlay</del> Information |                                  |                   |                                |
| PLOT NAME = Bottom Overlay                         | GENERATED : 1/22/2014 4:04:29 PM | TEXAS INSTRUMENTS |                                |

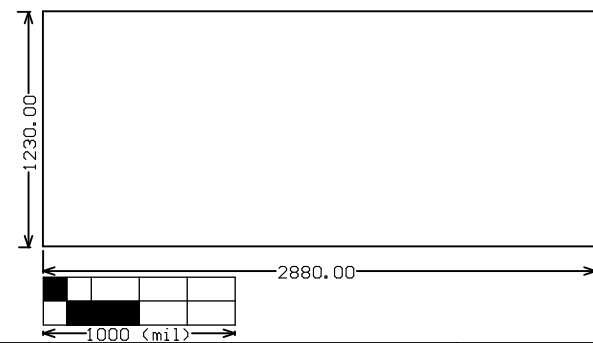




| Symbol | Hit Count        | Tool Size           | Plated | Hole Type |
|--------|------------------|---------------------|--------|-----------|
| ▽      | 8                | 7.874mil (0.2mm)    | PTH    | Round     |
| □      | 316              | 10mil (0.254mm)     | PTH    | Round     |
| ○      | 16               | 12mil (0.305mm)     | PTH    | Round     |
| ×      | 3                | 19.685mil (0.5mm)   | PTH    | Round     |
| ☆      | 2                | 35.433mil (0.9mm)   | NPTH   | Round     |
| ◇      | 2                | 40mil (1.016mm)     | PTH    | Round     |
| ⊕      | 9                | 47.244mil (1.2mm)   | PTH    | Round     |
| ⊗      | 4                | 51.181mil (1.3mm)   | PTH    | Round     |
| □      | 2                | 125.197mil (3.18mm) | PTH    | Round     |
|        | <b>362 Total</b> |                     |        |           |

Drill Table

|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: SAT0015                 | REV: E2           | SUN REV: Not In VersionControl |
| LAYER NAME = Drill Drawing       |                                  |                   |                                |
| PLOT NAME = Drill Drawing        | GENERATED : 1/22/2014 4:04:29 PM | TEXAS INSTRUMENTS |                                |



|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: SAT0015                 | REV: E2           | SVN REV: Not In VersionControl |
| LAYER NAME = M21 BoardDimensions |                                  |                   |                                |
| PLOT NAME = Board Dimensions     | GENERATED : 1/22/2014 4:04:30 PM | TEXAS INSTRUMENTS |                                |

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